

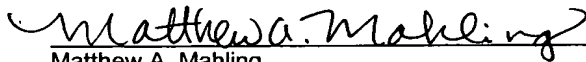
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application)	<u>PATENT APPLICATION</u>
Inventors: Stephen P. DeOrnellas, et al.)	
Appl. No.: Unknown)	
Confirm No.: Unassigned)	
Filed: Herewith)	<u>Customer No. 23910</u>
Title: METHOD FOR MINIMIZING THE CRITICAL DIMENSION GROWTH OF A FEATURE ON A SEMICONDUCTOR WAFER)	

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 (Signature)
Matthew A. Mahling
Signature Date: June 13, 2001

PRELIMINARY AMENDMENT

Box PATENT APPLICATION
Commissioner for Patents
Washington, DC 20231

Dear Sir:

Before calculating the filing fee, please amend the subject application as follows.

In the Specification:

Prior to the first line of the specification, delete any amendatory material and insert --This application is a Continuation of Serial No. 09/505,420, filed February 16, 2000, which is a Divisional of Serial No. 08/974,089, filed November 19, 1997, now U.S. Patent No. 6,046,116.--